

# Part Number: XZFMDK05A2

SURFACE MOUNT DISPLAY

### **Features**

- 0.2 inch digit height
- Robust package
- Low power consumption
- Standard configuration: Gray face w/ white segments
- Standard Package: 300pcs/ Reel • MSL (Moisture Sensitivity Level): 2a
- RoHS Compliant





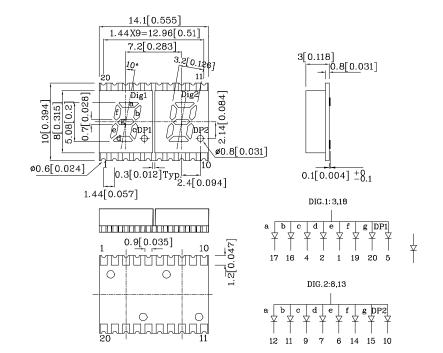


### OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE

SENSITIVE DEVICES

ATTENTION

# **Package Schematics**



- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. Specifications are subject to change without notice.
- 3. The gap between the reflector and PCB shall not exceed 0.25mm.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Red (AlGaInP)	Unit
Reverse Voltage	$V_{\mathrm{R}}$	5	V
Forward Current	$I_{\mathrm{F}}$	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\mathrm{FS}}$	185	mA
Power Dissipation	$P_{D}$	75	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	C

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

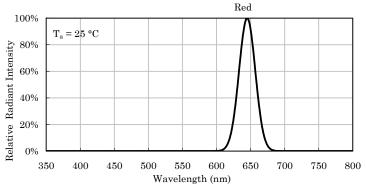
Operating Characteristics (T <sub>A</sub> =25°C)		Red (AlGaInP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	1.85	V
Forward Voltage (Max.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	2.35	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	μA
Wavelength of Peak Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$	λΡ	645*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$	λD	630*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =10mA)	$\triangle \lambda$	28	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	35	pF

Part Number	Emitting Color	Emitting Material	CIE127-2007* (I <sub>F</sub> =10mA) ucd	Wavelength CIE127-2007* nm λP	Description
			min. typ.		
XZFMDK05A2	Red	AlGaInP	14000 29990 3600* 8090*	645*	Common Anode, Rt.Hand Decimal.

<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Feb 22,2019

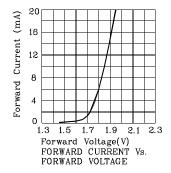


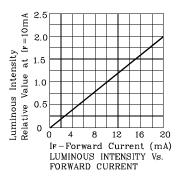


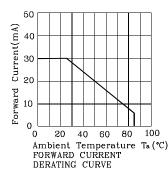


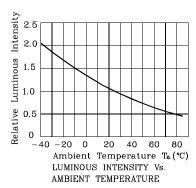
Relative Intensity Vs. CIE Wavelength

## **❖** Red



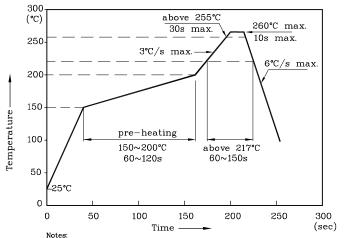






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

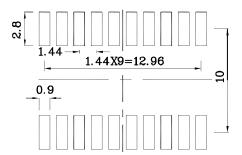


- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow.
- Do not apply any stress to the LED during high temperature conditions.
  Maximum number of soldering passes: 2

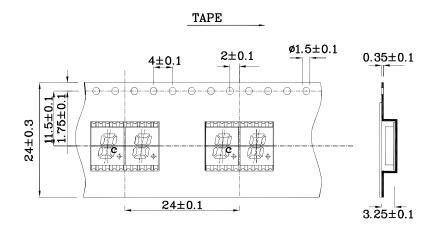




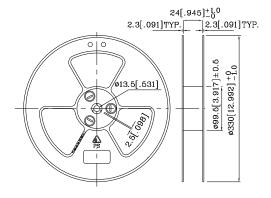
# **❖** Recommended Soldering Pattern (Units: mm; Tolerance: ±0.15)



# \* Tape Specification (Units:mm)



# \* Reel Dimension



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

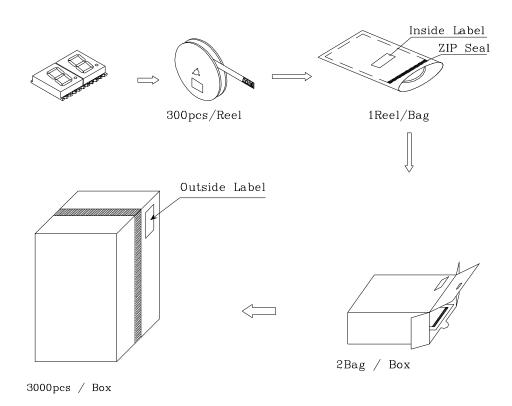
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

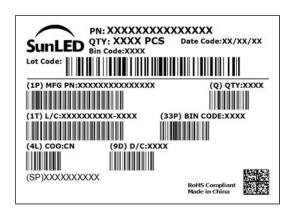
Note: Accuracy may depend on the sorting parameters.





## PACKING & LABEL SPECIFICATIONS





# TERMS OF USE

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